Self-Protected Low Side Driver with Temperature and Current Limit

65 V, 7.0 A, Single N-Channel

NCV8406A, NCV8406B

NCV8406A/B is a three terminal protected Low-Side Smart Discrete device. The protection features include overcurrent, overtemperature, ESD and integrated Drain-to-Gate clamping for overvoltage protection. This device offers protection and is suitable for harsh automotive environments.

Features

- Short Circuit Protection
- Thermal Shutdown with Automatic Restart
- Over Voltage Protection
- Integrated Clamp for Inductive Switching
- ESD Protection
- dV/dt Robustness
- Analog Drive Capability (Logic Level Input)
- These Devices are Faster than the Rest of the NCV Devices
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

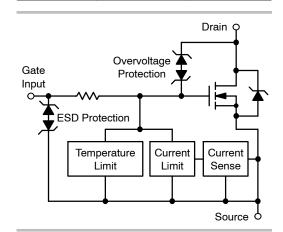
- Switch a Variety of Resistive, Inductive and Capacitive Loads
- Can Replace Electromechanical Relays and Discrete Circuits
- Automotive / Industrial

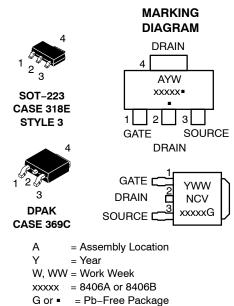


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V _{DSS} (Clamped)	R _{DS(on)} TYP	I _D TYP (Limited)
65 V	210 m Ω	7.0 A





ORDERING INFORMATION

(Note: Microdot may be in either location)

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage Internally Clamped	V _{DSS}	60	Vdc
Gate-to-Source Voltage	V _{GS}	±14	Vdc
Drain Current Continuous	۱ _D	Internally	/ Limited
Total Power Dissipation – SOT–223 Version @ $T_A = 25^{\circ}C$ (Note 1) @ $T_A = 25^{\circ}C$ (Note 2)	P _D	1.25 1.81	W
Total Power Dissipation – DPAK Version @ T _A = 25°C (Note 1) @ T _A = 25°C (Note 2)	P _D	1.31 2.31	W
Thermal Resistance – SOT-223 Version Junction-to-Soldering Point Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	R _{θJS} R _{θJA} R _{θJA}	7.0 100 69	°C/W
Thermal Resistance – DPAK Version Junction-to-Soldering Point Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	R _{0JS} R _{0JA} R _{0JA}	1.0 95 54	°C/W
Single Pulse Inductive Load Switching Energy (Starting T _J = 25°C, V _{DD} = 50 Vdc, V _{GS} = 5.0 Vdc, $I_L = 2.1 \text{ Apk}$, L = 50 mH, $R_G = 25 \Omega$)	E _{AS}	110	mJ
Load Dump Voltage (V_{GS} = 0 and 10 V, R_I = 2 Ω , R _L = 7 Ω , t _d = 400 ms)	V _{LD}	75	V
Operating Junction Temperature Range	TJ	-40 to 150	°C
Storage Temperature Range	T _{stg}	-55 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Surface mounted onto minimum pad size (100 sq/mm) FR4 PCB, 1 oz cu.
Mounted onto 1" square pad size (700 sq/mm) FR4 PCB, 1 oz cu.

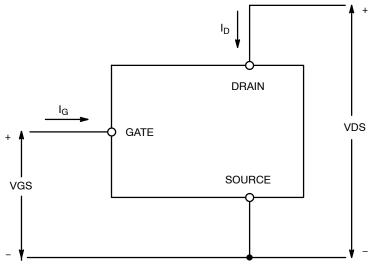


Figure 1. Voltage and Current Convention

MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic			Min	Тур	Max	Unit		
OFF CHARACTERISTICS								
Drain-to-Source Clamped Breakdown Voltage (V_{GS} = 0 V, I_D = 2 mA)		V _{(BR)DSS}	60	65	70	V		
Zero Gate Voltage Drain Current ($V_{DS} = 52 \text{ V}, V_{GS} = 0 \text{ V}$)		I _{DSS}	_	22	100	μΑ		
Gate Input Current (V _{GS} = 5.0 V, V _{DS} = 0 V)				I _{GSS}	_	30	100	μA
ON CHARACTERISTICS								
Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 150 \ \mu$ A) Threshold Temperature Coefficient		V _{GS(th)}	1.2 -	1.66 4.0	2.0	V -mV/°C		
Static Drain-to-Source On-Resistance (Note 3) $(V_{GS} = 10 \text{ V}, I_D = 2.0 \text{ A}, T_J @ 25^{\circ}\text{C})$		R _{DS(on)}	-	185	210	mΩ		
Static Drain-to-Source On-Resistance (Note 3) ($V_{GS} = 5.0 \text{ V}, I_D = 2.0 \text{ A}, T_J @ 25^{\circ}\text{C}$) ($V_{GS} = 5.0 \text{ V}, I_D = 2.0 \text{ A}, T_J @ 150^{\circ}\text{C}$)		R _{DS(on)}		210 445	240 520	mΩ		
Source–Drain Forward On Vo $(I_S = 7.0 \text{ A}, V_{GS} = 0 \text{ V})$	Itage	V _{SD}	I	0.9	1.1	V		
SWITCHING CHARACTERIS	TICS (Note 6)							
Turn-on Delay Time	$\begin{array}{l} {\sf R}_{\sf L} = 6.6 \; \Omega, \; {\sf V}_{in} = \; 0 \; \text{to} \; 10 \; {\sf V}, \\ {\sf V}_{\sf DD} = \; 13.8 \; {\sf V}, \; {\sf I}_{\sf D} = 2.0 \; {\sf A}, \; 10\% \; {\sf V}_{in} \; \text{to} \; 10\% \; {\sf I}_{\sf D} \end{array}$	td _(on)	-	127	-	ns		
Turn-on Rise Time	R_L = 6.6 Ω, V_{in} = 0 to 10 V, V_{DD} = 13.8 V, I_D = 2.0 A, 10% I_D to 90% I_D	t _{rise}	_	486	-	ns		
Turn-off Delay Time	$\begin{array}{l} R_L = 6.6 \; \Omega, \; V_{in} = \; 0 \; to \; 10 \; V, \\ V_{DD} = \; 13.8 \; V, \; I_D = 2.0 \; A, \; 90\% \; V_{in} \; to \; 90\% \; I_D \end{array}$	td _(off)	-	1600	-	ns		
Turn-off Fall Time	R _L = 6.6 Ω, V _{in} = 0 to 10 V, V _{DD} = 13.8 V, I _D = 2.0 A, 90% I _D to 10% I _D	t _{fall}	-	692	-	ns		
Slew Rate ON	R_L = 6.6 Ω, V_{in} = 0 to 10 V, V_{DD} = 13.8 V, I_D = 2.0 A, 70% to 50% V_{DD}	$\mathrm{dV}_{\mathrm{DS}}/\mathrm{dT}_{\mathrm{on}}$	-	79	-	V/μs		
Slew Rate OFF	R _L = 6.6 Ω, V _{in} = 0 to 10 V, V _{DD} = 13.8 V, I _D = 2.0 A, 50% to 70% V _{DD}	$\mathrm{dV}_{\mathrm{DS}}/\mathrm{dT}_{\mathrm{off}}$	-	27	-	V/μs		
SELF PROTECTION CHARAC	CTERISTICS (Note 4)							
Current Limit	$ \begin{array}{l} V_{DS} = 10 \; \text{V}, \; V_{GS} = 5.0 \; \text{V}, \; T_J = 25^\circ\text{C} \; (\text{Note} \; 5) \\ V_{DS} = 10 \; \text{V}, \; V_{GS} = 5.0 \; \text{V}, \; T_J = 150^\circ\text{C} \; (\text{Notes} \; 5, \; 6) \\ V_{DS} = 10 \; \text{V}, \; V_{GS} = 10 \; \text{V}, \; T_J = 25^\circ\text{C} \; (\text{Notes} \; 5) \\ \end{array} $	I _{LIM}	5.0 3.5 6.5	7.0 4.5 8.5	9.5 6.0 10.5	A		
Temperature Limit (Turn-off)	V _{GS} = 5.0 V (Note 6)	T _{LIM(off)}	150	180	200	°C		
Thermal Hysteresis	V _{GS} = 5.0 V	$\Delta T_{LIM(on)}$	-	10	-	°C		
Temperature Limit (Turn-off)	V _{GS} = 10 V (Note 6)	T _{LIM(off)}	150	180	200	°C		
Thermal Hysteresis	V _{GS} = 10 V	$\Delta T_{LIM(on)}$	-	20	-	°C		
Input Current during Thermal Fault		I _{g(fault)}		5.9 12.3	-	mA		
SD ELECTRICAL CHARACT	TERISTICS							
Electro Statio Discharge Con	1.10	ESD		T	I			

Elec	tro-Static Discharge Capability	ESD				V	
	Human Body Model (HBM)		6000	-	-	l I	
	Machine Model (MM)		500	-	-		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%. 4. Fault conditions are viewed as beyond the normal operating range of the part.

5. Current limit measured at 380 μ s after gate pulse. 6. Not subject to production test.

TYPICAL PERFORMANCE CURVES

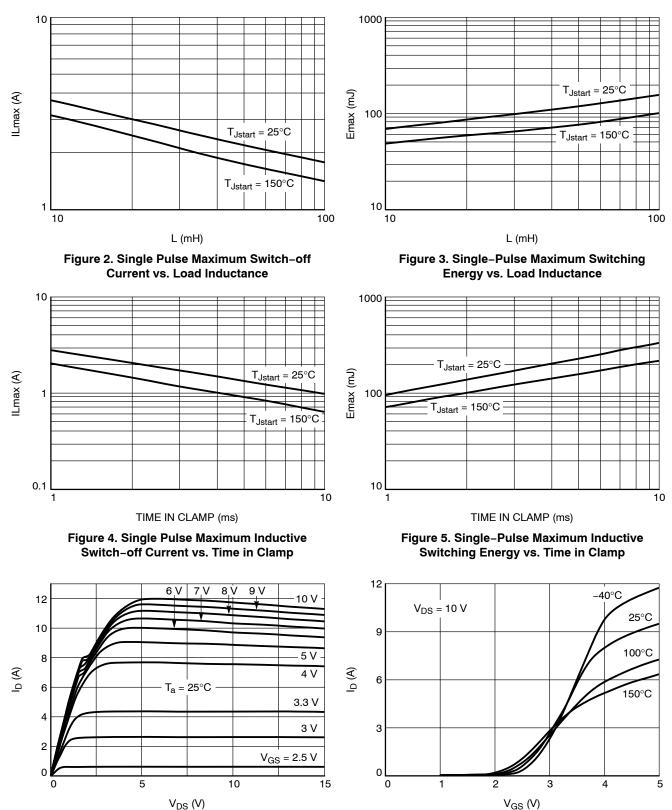
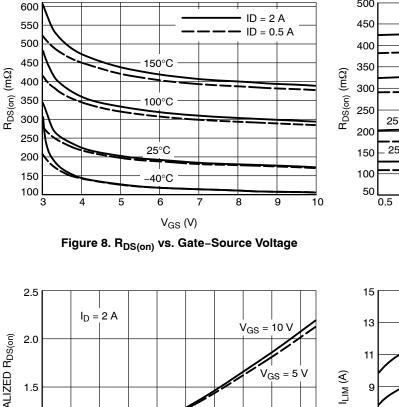
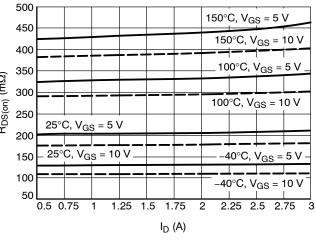


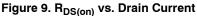
Figure 7. Transfer Characteristics

Figure 6. On-state Output Characteristics

TYPICAL PERFORMANCE CURVES







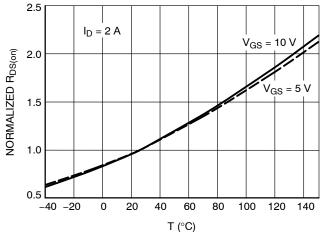
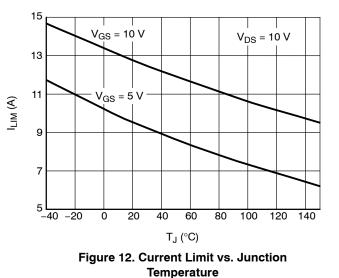
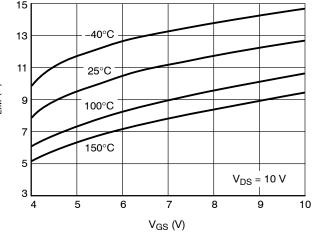


Figure 10. Normalized R_{DS(on)} vs. Temperature







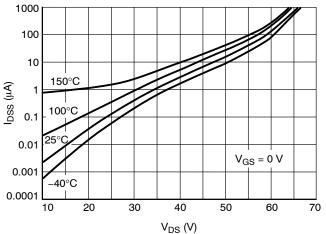
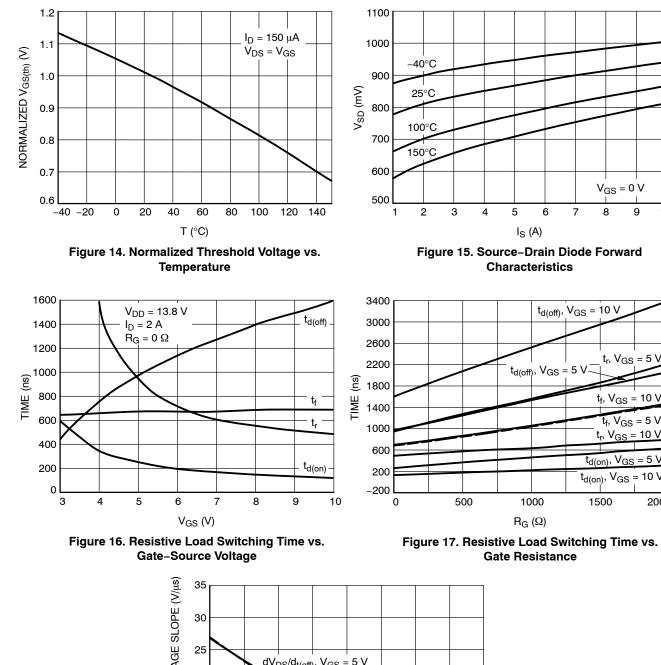


Figure 13. Drain-to-Source Leakage Current

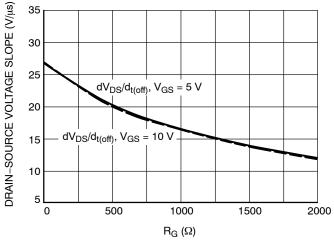
TYPICAL PERFORMANCE CURVES

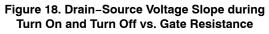


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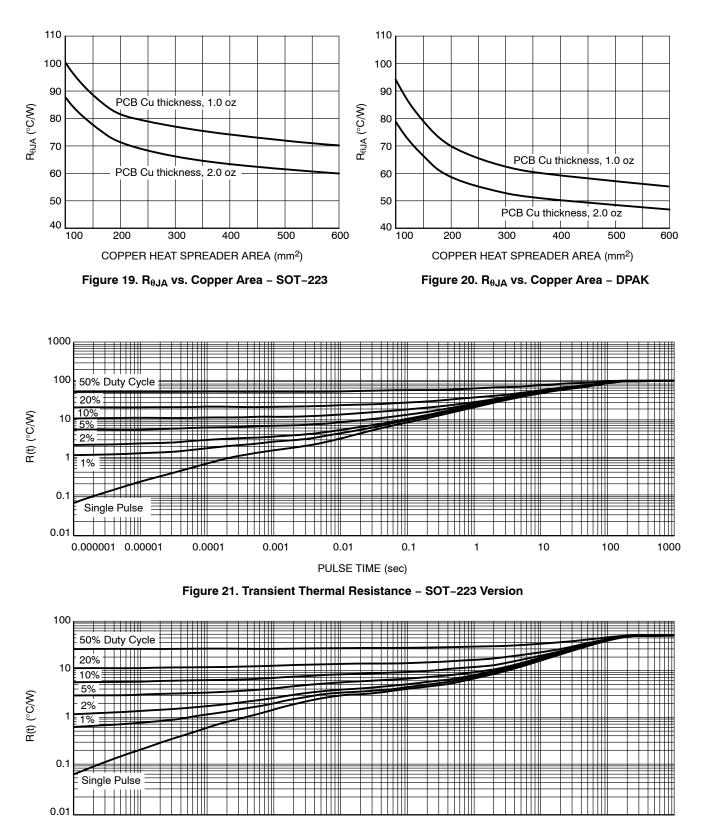
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2000





TYPICAL PERFORMANCE CURVES



PULSE TIME (sec)

0.1

1

10

100

1000

0.01

0.000001 0.00001

0.0001

0.001

Figure 22. Transient Thermal Resistance – DPAK Version

TEST CIRCUITS AND WAVEFORMS

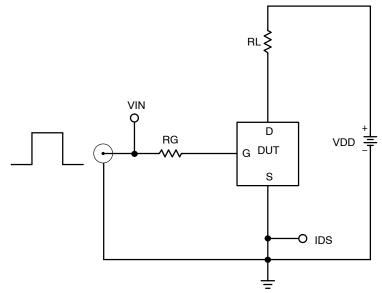


Figure 23. Resistive Load Switching Test Circuit

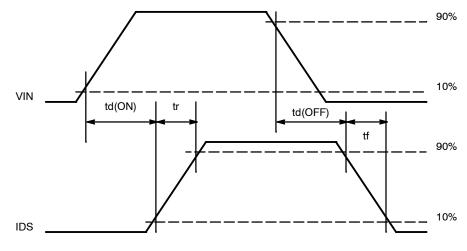


Figure 24. Resistive Load Switching Waveforms

TEST CIRCUITS AND WAVEFORMS

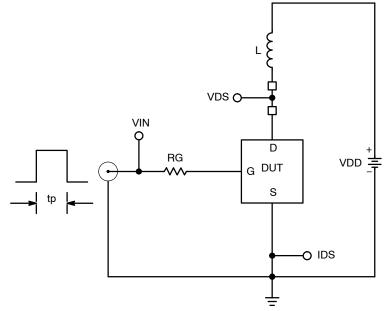


Figure 25. Inductive Load Switching Test Circuit

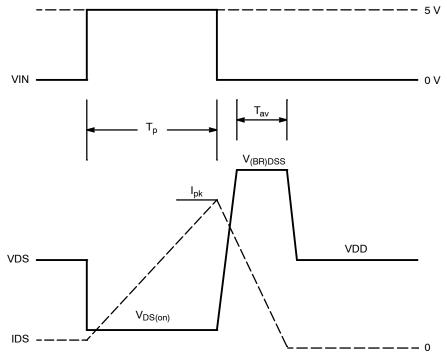


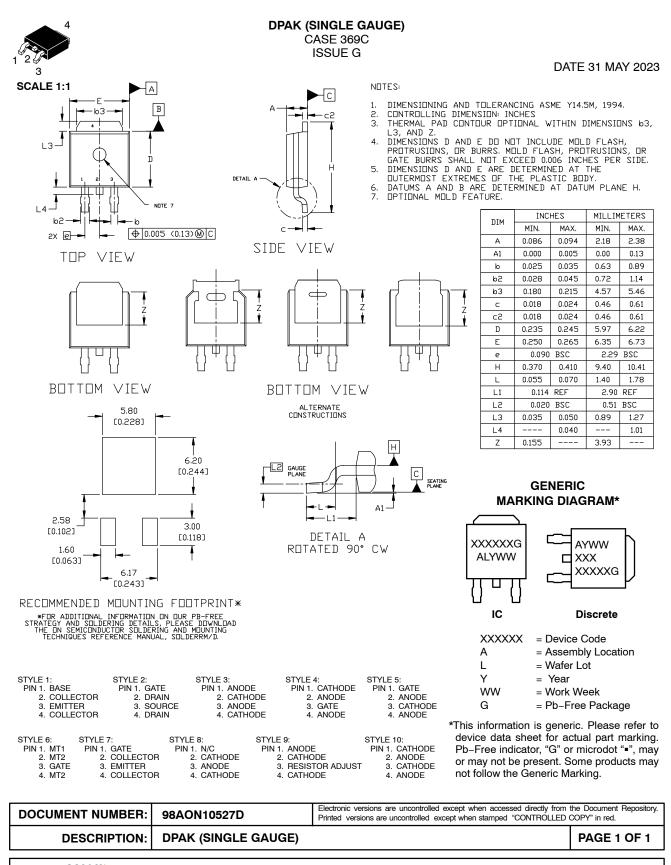
Figure 26. Inductive Load Switching Waveforms

ORDERING INFORMATION

Device	Package	Shipping [†]
NCV8406ASTT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
NCV8406ASTT3G	SOT-223 (Pb-Free)	4000 / Tape & Reel
NCV8406ADTRKG	DPAK (Pb-Free)	2500 / Tape & Reel
NCV8406BDTRKG	DPAK (Pb–Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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